

#### **N-Channel Enhancement Mode MOSFET**

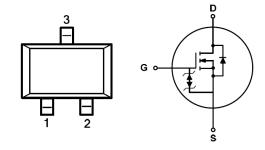
#### **Features**

- Surface-mounted package
- Advanced trench cell design
- Extremely low threshold voltage
- ESD protected (HBM > 2KV)

#### **Quick reference**

- $\bullet$  BV  $\geq$  60 V
- $\bullet$  Ptot  $\leq 0.83 \text{ W}$
- $I_D \leq 0.5 A$
- $R_{DS(ON)} \leq 3 \Omega @ V_{GS} = 10 V$
- $R_{DS(ON)} \le 4 \Omega @ V_{GS} = 4.5 V$

#### **SOT-23**



Top View
1:Gate(G) 2:Source(S) 3:Drain(D)

#### **Limiting Values**

Symbol	Parameter	Conditions		Max	Unit	
V <sub>DS</sub>	Drain-Source Voltage	T <sub>A</sub> = 25 °C	-	60	٧	
V <sub>GS</sub>	Gate-Source Voltage	T <sub>A</sub> = 25 °C	-	± 20	٧	
I <sub>D</sub> *	Drain Current	T <sub>A</sub> = 25 °C, V <sub>GS</sub> = 10 V	-	0.5	Α	
I <sub>DM</sub> *.**	Pulsed Drain Current	T <sub>A</sub> = 25 °C, V <sub>GS</sub> = 10 V	-	1.7	Α	
P <sub>tot</sub> *	Total Power Dissipation	T <sub>A</sub> = 25 °C	-	0.83	W	
		T <sub>A</sub> = 100 °C	-	0.33		
T <sub>stg</sub>	Storage Temperature		- 55	150	Ç	
TJ	Junction Temperature		-	150	Ç	
I <sub>S</sub> *	Diode Forward Current	T <sub>A</sub> = 25 °C	-	0.4	Α	
R <sub>eJA</sub> *	Thermal Resistance- Junction to Ambient		-	150	°C / W	

Notes: \* Surface Mounted on 1 in 2 pad area,  $t \le 10$  sec

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<sup>\*\*</sup> Pulse width  $\leq 300 \mu s$ , duty cycle  $\leq 2 \%$ 



## **Electrical Characteristics** (TA = 25 °C Unless Otherwise Noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
Static Characteristics								
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>DS</sub> = 250 μA		60	-	-	V	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>DS</sub> = 250 μA		1.0	1.6	2.5	٧	
I <sub>DSS</sub>	Drain Leakage Current	V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V		-	-	1	μΑ	
			T <sub>J</sub> = 85 °C	_	-	30	μΑ	
I <sub>GSS</sub>	Gate Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS}$	; = 0 V	-	-	± 10	μΑ	
D a	On-State Resistance	$V_{GS}$ = 10 V, $I_{DS}$ =	0.4 A		1.9	3.0	(	
R <sub>DS(ON)</sub>		V <sub>GS</sub> = 4.5 V, I <sub>DS</sub> = 0.3 A		-	2.4	4.0	Ω	
Diode Characteristics								
V <sub>SD</sub> <sup>a</sup>	Diode Forward Voltage	I <sub>SD</sub> = 0.4 A, V <sub>GS</sub> = 0 V		-	0.7	1.3	٧	
t <sub>rr</sub>	Reverse Recovery Time	$I_{SD} = 0.4 \text{ A}, \text{ d}I_{SD} / \text{ dt} = 100 \text{ A} / \mu \text{s}$		-	40	-	ns	
Q <sub>rr</sub>	Reverse Recovery Charge			-	40	-	nC	
Dynamic Characteristics <sup>b</sup>								
R <sub>G</sub>	Gate Resistance	$V_{GS} = V_{DS} = 0 V$ ,	F = 1 MHz	-	130	-	Ω	
C <sub>iss</sub>	Input Capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}$ Frequency = 1 MHz		-	30	-		
Coss	Output Capacitance			-	4.2	-	рF	
C <sub>rss</sub>	Reverse Transfer Capacitance			-	3	-		
t <sub>d</sub> (on)	Turn-on Delay Time	$V_{DS} = 30 \text{ V}, V_{GEN} = 10 \text{ V},$ $R_G = 25 \Omega, R_L = 150 \Omega,$ $I_{DS} = 0.2 \text{ A}$		-	3.9	9		
<b>t</b> r	Turn-on Rise Time			-	3.5	8	na	
t <sub>d</sub> (off)	Turn-off Delay Time			-	16	40	ns	
t <sub>f</sub>	Turn-off Fall Time			-	10	20		
Qg	Total Gate Charge	$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V},$ $I_{DS} = 0.4 \text{ A}$		-	305	-		
Q <sub>gs</sub>	Gate-Source Charge			-	85	-	рС	
$Q_{gd}$	Gate-Drain Charge			-	205	-		

Notes: a: Pulse test; pulse width  $\leq 300 \,\mu s$ , duty cycle  $\leq 2 \,\%$  b: Guaranteed by design, not subject to production testing

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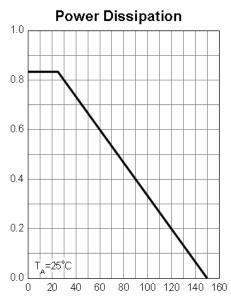
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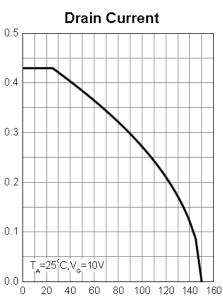
## **Typical Characteristics**





· Drain Current (A)

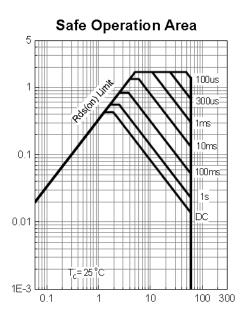
Normalized Effective Transient



T<sub>i</sub> - Junction Temperature (°C)

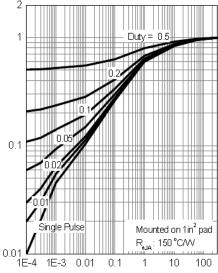
T<sub>i</sub> - Junction Temperature (°C)

# I<sub>D</sub> - Drain Current (A)



V<sub>DS</sub> - Drain-Source Voltage (V)

### Thermal Transient Impedance



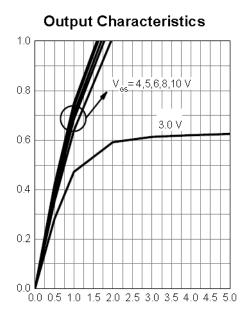
Square Wave Pulse Duration (sec)

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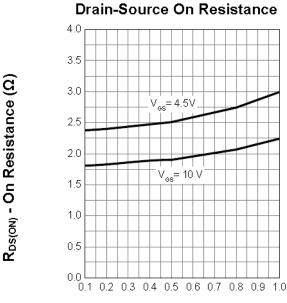


I<sub>D</sub> - Drain Current (A)



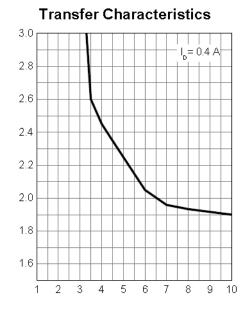
 $V_{\text{DS}}$  - Drain-Source Voltage (V)

Normalized Threshold Voltage



I<sub>D</sub> - Drain Current (A)

R<sub>DS(ON)</sub> - On Resistance (Ω)



V<sub>GS</sub> - Gate-Source Voltage (V)

Gate Threshold Voltage

1.6

1.4

1.2

1.0

0.8

0.6

0.4

0.2

0.0

-50 -25 0 25 50 75 100 125 150

T<sub>i</sub> - Junction Temperature (°C)

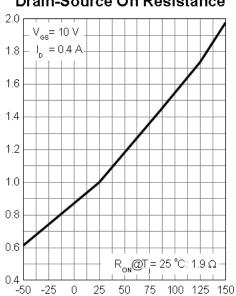
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Normalized On Resistance

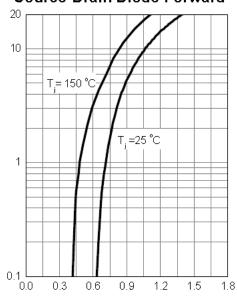
**Drain-Source On Resistance** 



Is - Source Current (A)

V<sub>GS</sub> - Gate-Source Voltage (V)

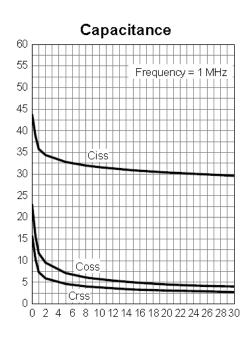
Source-Drain Diode Forward



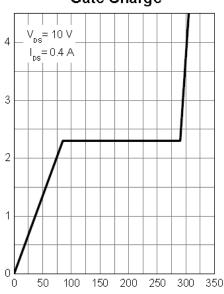
T<sub>j</sub> - Junction Temperature (°C)

V<sub>SD</sub> - Source-Drain Voltage (V)





Gate Charge



V<sub>DS</sub> - Drain-Source Voltage (V)

Q<sub>G</sub> - Gate Charge (pC)

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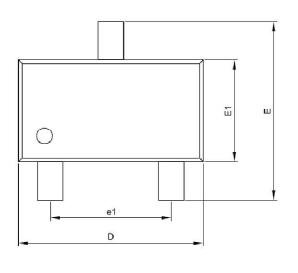


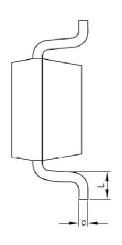


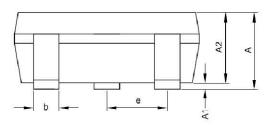


## **Package Dimensions**

#### SOT-23







Symbol	Dimensions In Millimeters			
Symbol	MIN.	MAX.		
Α		1.12		
A1	0.00	0.1		
A2	0.90	1.02		
D	2.90 BSC			
E	2.40 BSC			
E1	1.20	1.40		
С	0.08	0.25		
b	0.30	0.50		
е	0.95 BSC			
e1	1.90 BSC			
L	0.20	0.60		

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